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Attorney Docket No. 108298634US1  
Disclosure No. 01-0327.01

	<b>INFORMATION DISCLOSURE STATEMENT BY APPLICANT</b> Form PTO-1449 (Modified) (Use several sheets if necessary)			<b>COMPLETE IF KNOWN</b>	
				Application Number	10/674,869
				Confirmation Number	6310
				Filing Date	26 September 2003
				First Named Inventor	Leng Nam Yin
				Group Art Unit	<del>2844</del> 2822
Examiner Name	<del>Wael M. Fahmy</del> K. DUONG				
Sheet	1	of	1	Attorney Docket No.	108298634US1

U.S. PATENT DOCUMENTS						
Examiner Initials*	Cite No.	U.S. Patent or Application		Name of Patentee or Inventor of Cited Document	Date of Publication or Filing Date of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear
		NUMBER	Kind Code (if known)			
KED		6,521,993		Masayuki et al.	02/18/2003	

EXAMINER		DATE CONSIDERED	9/28/2004
*EXAMINER: Initial if reference considered, whether or not criteria is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to application(s).			

Express Mail No. EV335523071US

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Examiner Initials*	Cite No.	U.S. Patent or Application		Name of Patentee or Inventor of Cited Document	Date of Publication or Filing Date of Cited Document	Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear		
		NUMBER	Kind Code (if known)					
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		Office	NUMBER	Kind Code (if known)				
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EXAMINER <i>John B. Duong</i>	DATE CONSIDERED 9/28/2004
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				Group Art Unit	
				Examiner Name	
Sheet	2	of	2	Attorney Docket No.	108298634US1

OTHER PRIOR ART-NON PATENT LITERATURE DOCUMENTS			
Examiner Initials	Cite No.	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume issue number(s), publisher, city and/or country where published.	T
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